Dual 2-to-4 Decoder/ Demultiplexer

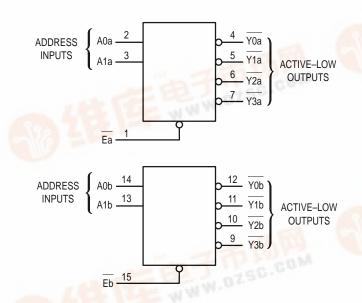
The MC74VHC139 is an advanced high speed CMOS 2–to–4 decoder/demultiplexer fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

When the device is enabled (E = low), it can be used for gating or as a data input for demultiplexing operations. When the enable input is held high, all four outputs are fixed high, independent of other inputs.

The internal circuit is composed of three stages, including a buffer output which provides high noise immunity and stable output. The inputs tolerate voltages up to 7V, allowing the interface of 5V systems to 3V systems.

- High Speed: tpD = 5.0ns (Typ) at VCC = 5V
- Low Power Dissipation: I_{CC} = 4μA (Max) at T_A = 25°C
- High Noise Immunity: VNIH = VNIL = 28% VCC
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Designed for 2V to 5.5V Operating Range
- Low Noise: Volp = 0.8 V (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300mA
- ESD Performance: HBM > 2000V; Machine Model > 200V
- Chip Complexity: 100 FETs or 25 Equivalent Gates

LOGIC DIAGRAM



MC74VHC139



D SUFFIX 16–LEAD SOIC PACKAGE CASE 751B–05



DT SUFFIX 16-LEAD TSSOP PACKAGE CASE 948F-01



M SUFFIX 16-LEAD SOIC EIAJ PACKAGE CASE 966-01

ORDERING INFORMATION

MC74VHCXXXD SOIC
MC74VHCXXXDT TSSOP
MC74VHCXXXM SOIC EIAJ

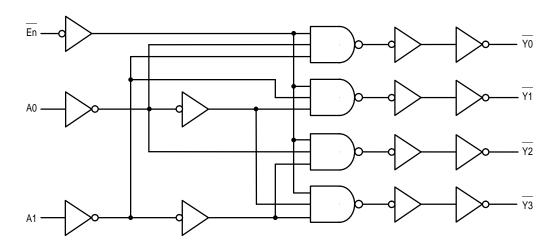
PIN ASSIGNMENT Ea [15 ☐ Eb A0a [A0b A1a Y0a [13 🛮 A1b 12 Y0b Y1a [Y2a [b 11 Y₁b Y2b Y3a [10 9 GND [

| Inputs | | | | Outputs | | | | |
|--------|----|----|----|---------|----|----|--|--|
| E | A1 | Α0 | Y0 | Y1 | Y2 | Y3 | | |
| Н | Х | Χ | Н | Н | Н | Н | | |
| L | L | L | L | Н | Н | Н | | |
| L | L | Н | Н | L | Н | Н | | |
| L | Н | L | Н | Н | L | Н | | |
| L | Н | Н | Н | Н | Н | L | | |

FUNCTION TABLE



EXPANDED LOGIC DIAGRAM (1/2 OF DEVICE)



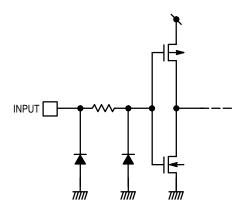


Figure 1. Input Equivalent Circuit

MAXIMUM RATINGS*

| Symbol | Parameter | Value | Unit | |
|------------------|--|----------------------------------|-------------------------------|----|
| VCC | DC Supply Voltage | | - 0.5 to + 7.0 | V |
| V _{in} | DC Input Voltage | | - 0.5 to + 7.0 | V |
| V _{out} | DC Output Voltage | | -0.5 to V _{CC} + 0.5 | V |
| lικ | Input Diode Current | | – 20 | mA |
| lok | Output Diode Current | | ± 20 | mA |
| l _{out} | DC Output Current, per Pin | | ± 25 | mA |
| Icc | DC Supply Current, V _{CC} and GND | Pins | ± 75 | mA |
| PD | Power Dissipation in Still Air, | SOIC Packages† TSSOP Package† | 500 450 | mW |
| T _{stg} | Storage Temperature | | - 65 to + 150 | °C |

^{*} Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute—maximum—rated conditions is not implied.

†Derating — SOIC Packages: – 7 mW/°C from 65° to 125°C TSSOP Package: – 6.1 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | | Min | Max | Unit |
|---------------------------------|---|--|--------|-----------|------|
| VCC | DC Supply Voltage | | 2.0 | 5.5 | V |
| V _{in} | DC Input Voltage | | 0 | 5.5 | V |
| V _{out} | DC Output Voltage | | 0 | VCC | V |
| TA | Operating Temperature | | - 40 | + 85 | °C |
| t _r , t _f | Input Rise and Fall Time Vol. (Figure 1) Vol. | $CC = 3.3V \pm 0.3V$ $CC = 5.0V \pm 0.5V$ | 0 0 | 100 20 | ns/V |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND \leq (V_{in} or V_{out}) \leq V_{CC} . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS

| | | | VCC | | T _A = 25°C | ; | $T_A = -40$ |) to 85°C | |
|--------|--------------------------------------|---|----------------------|-------------------------------|-----------------------|-------------------------------|-------------------------------|-------------------------------|------|
| Symbol | Parameter | Test Conditions | v | Min | Тур | Max | Min | Max | Unit |
| VIH | Minimum High-Level Input Voltage | | 2.0 3.0 to 5.5 | 1.50 V _{CC} x 0.7 | | | 1.50 V _{CC} x 0.7 | | V |
| VIL | Maximum Low–Level Input Voltage | | 2.0 3.0 to 5.5 | | | 0.50 V _{CC} x 0.3 | | 0.50 V _{CC} x 0.3 | V |
| VOH | Minimum High-Level Output Voltage | V _{in} = V _{IH} or V _{IL} I _{OH} = – 50μA | 2.0 3.0 4.5 | 1.9 2.9 4.4 | 2.0 3.0 4.5 | | 1.9 2.9 4.4 | | V |
| | | $V_{in} = V_{IH} \text{ or } V_{IL}$ $I_{OH} = -4\text{mA}$ $I_{OH} = -8\text{mA}$ | 3.0 4.5 | 2.58 3.94 | | | 2.48 3.80 | | |
| VOL | Maximum Low–Level Output Voltage | $V_{\text{in}} = V_{\text{IH}} \text{ or } V_{\text{IL}}$ $I_{\text{OL}} = 50 \mu \text{A}$ | 2.0 3.0 4.5 | | 0.0 0.0 0.0 | 0.1 0.1 0.1 | | 0.1 0.1 0.1 | V |
| | | $V_{in} = V_{IH}$ or V_{IL} $I_{OL} = 4mA$ $I_{OL} = 8mA$ | 3.0 4.5 | | | 0.36 0.36 | | 0.44 0.44 | |

DC ELECTRICAL CHARACTERISTICS

| | | | v _{CC} | T _A = 25°C | | $T_A = -40$ |) to 85°C | | |
|-----------------|-------------------------------------|--|-----------------|-----------------------|-----|-------------|-----------|-------|------|
| Symbol | Parameter | Test Conditions | v | Min | Тур | Max | Min | Max | Unit |
| l _{in} | Maximum Input Leakage Current | V _{in} = 5.5 V or GND | 0 to 5.5 | | | ± 0.1 | | ± 1.0 | μА |
| ICC | Maximum Quiescent Supply Current | V _{in} = V _{CC} or GND | 5.5 | | | 4.0 | | 40.0 | μА |

AC ELECTRICAL CHARACTERISTICS (Input $t_f = t_f = 3.0$ ns)

| | | | | | T _A = 25°C | | T _A = - 40 |) to 85°C | |
|--|--------------------------------------|--------------------------|------------------------------|-----|-----------------------|--------------|-----------------------|--------------|------|
| Symbol | Parameter | Test Condi | tions | Min | Тур | Max | Min | Max | Unit |
| t _{PLH} , t _{PHL} | Maximum Propagation Delay, A to Y | $V_{CC} = 3.3 \pm 0.3 V$ | $C_L = 15pF$ $C_L = 50pF$ | | 7.2 9.7 | 11.0 14.5 | 1.0 1.0 | 13.0 16.5 | ns |
| | | $V_{CC} = 5.0 \pm 0.5 V$ | $C_L = 15pF$ $C_L = 50pF$ | | 5.0 6.5 | 7.2 9.2 | 1.0 1.0 | 8.5 10.5 | |
| tPLH, tPHL | Maximum Propagation Delay, E to Y | $V_{CC} = 3.3 \pm 0.3 V$ | $C_L = 15pF$ $C_L = 50pF$ | | 6.4 8.9 | 9.2 12.7 | 1.0 1.0 | 11.0 14.5 | ns |
| | | $V_{CC} = 5.0 \pm 0.5 V$ | $C_L = 15pF$ $C_L = 50pF$ | | 4.4 5.9 | 6.3 8.3 | 1.0 1.0 | 7.5 9.5 | |
| C _{in} | Maximum Input Capacitance | | | | 4 | 10 | | 10 | pF |

| | | Typical @ 25°C, V _{CC} = 5.0V | |
|----------|---|--|----|
| C_{PD} | Power Dissipation Capacitance (Note NO TAG) | 26 | pF |

^{1.} CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: ICC(OPR) = CPD • VCC • f_{in} + I_{CC}/2 (per decoder). CPD is used to determine the no–load dynamic power consumption; PD = CPD • VCC² • f_{in} + I_{CC} • VCC.

SWITCHING WAVEFORMS

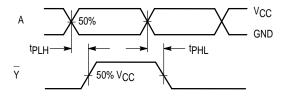
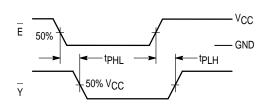
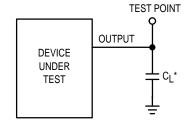


Figure 2.





^{*} Includes all probe and jig capacitance

Figure 3.

Figure 4. Test Circuit

INCHES

MIN MAX

0.054 | 0.068

0.014 0.019

0.016 0.049 0.050 BSC

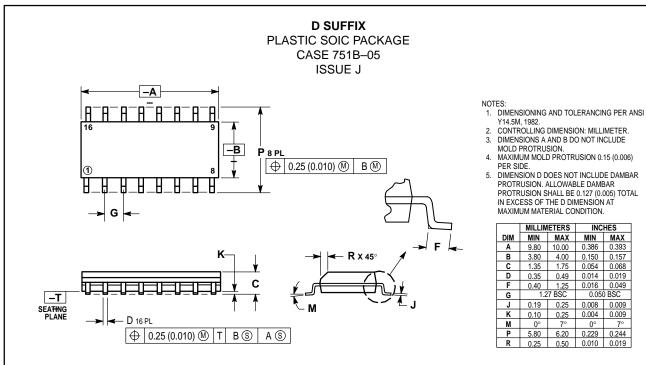
0.008 0.009

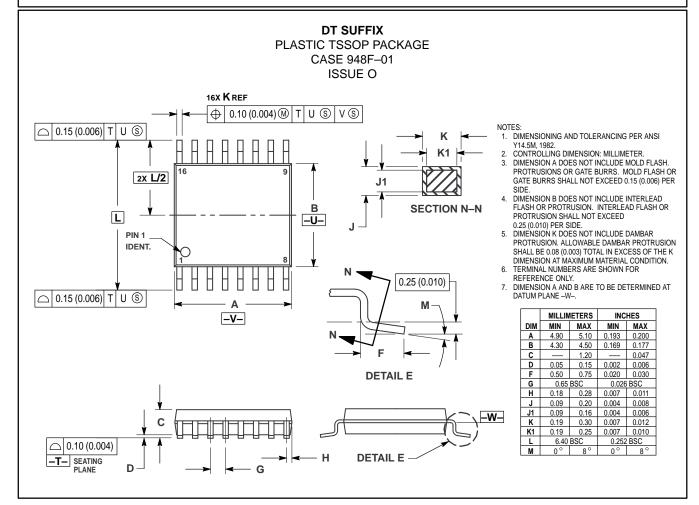
0.004 0.009

0.229 0.244

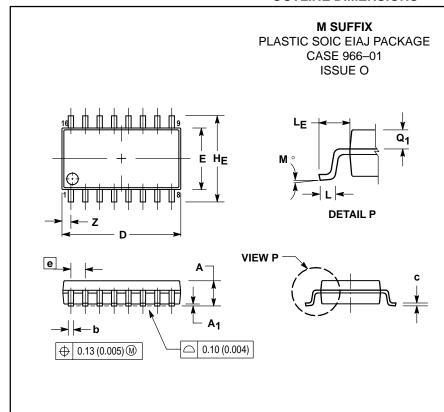
0°

OUTLINE DIMENSIONS





OUTLINE DIMENSIONS



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE, MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE
- 4. TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.
 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH
 DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT, MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

| | MILLIN | IETERS | INC | HES | | |
|----------------|--------|--------|-------|-------|--|--|
| DIM | MIN | MAX | MIN | MAX | | |
| Α | | 2.05 | | 0.081 | | |
| Α ₁ | 0.05 | 0.20 | 0.002 | 0.008 | | |
| p | 0.35 | 0.50 | 0.014 | 0.020 | | |
| С | 0.18 | 0.27 | 0.007 | 0.011 | | |
| D | 9.90 | 10.50 | 0.390 | 0.413 | | |
| Е | 5.10 | 5.45 | 0.201 | 0.215 | | |
| е | 1.27 | BSC | 0.050 | BSC | | |
| ΗE | 7.40 | 8.20 | 0.291 | 0.323 | | |
| L | 0.50 | 0.85 | 0.020 | 0.033 | | |
| LF | 1.10 | 1.50 | 0.043 | 0.059 | | |
| M | 0 ° | 10° | 0 ° | 10 ° | | |
| Q1 | 0.70 | 0.90 | 0.028 | 0.035 | | |
| Z | | 0.78 | | 0.031 | | |

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